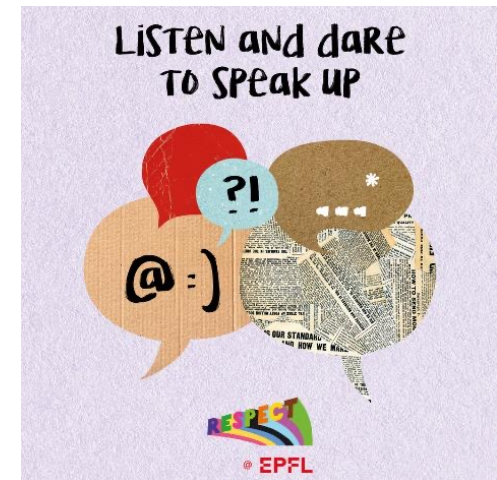
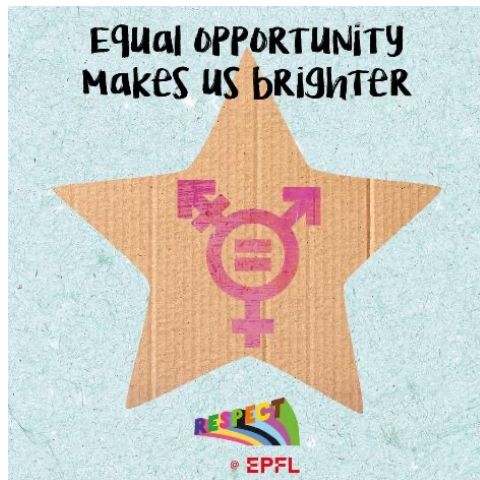




The EPFL logo is displayed in a large, bold, red, sans-serif font. It is positioned to the right of a solid red vertical bar that runs down the left side of the slide.

Génie Electrique et Electronique
Master program
Prof. Elison Matioli

EE-557

Semiconductor devices I

Introduction

EE-557 - Semiconductor devices I

Prof. Elison Matioli
POWERlab - EPFL

Why are you taking this class?

What do will you learn?

Why is that important?

Goals of this class

What do they all have in common?

CPUs

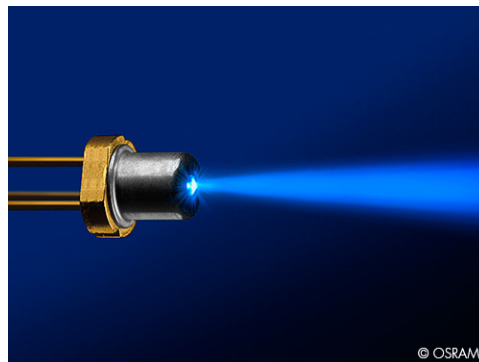
Cell phone

LED

Solar cell

Lasers

Power converter



Why is that important?

European Chips Act

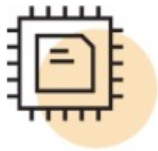
the EU will address semiconductor shortages and strengthen Europe's technological leadership. It will mobilise more than € 43 billion of public and private investments and set measures to prepare, anticipate and swiftly respond to any future supply chain disruptions, together with Member States and our international partners.



Strengthen Europe's research and technology leadership towards smaller and faster chips



Put in place a framework to increase production capacity to 20% of the global market by 2030



Build and reinforce capacity to innovate in the design, manufacturing and packaging of advanced chips



Develop an in-depth understanding of the global semiconductor supply chains



Address the skills shortage, attract new talent and support the emergence of a skilled workforce

- Motivation: why semiconductor devices are key for the 21st century
- Introduce the basics of semiconductors and advance towards compound semiconductors
- Study some of the key electronic materials:
Silicon, GaAs, GaN, SiC, Diamond

and devices of today:
Diodes, MOSFETs, HEMTs, Power transistors
LEDs, solar cells
- How these components are fabricated in state-of-the-art cleanroom environment?
- How do we measure some of their key properties?
- Final goal of these components:
Digital applications
Efficient energy conversion
LED lighting
Photovoltaic

What are semiconductor devices?

What is a semiconductor???

Compare Glass, Metal and Semiconductor

metal



Copper:
 $\rho = 1.7 \times 10^{-8} \Omega\text{m}$

glass



Glass:
 $\rho = 10^{11} - 10^{15} \Omega\text{m}$

What is a semiconductor???

Compare Glass, Metal and Semiconductor

Silicon intrinsic:

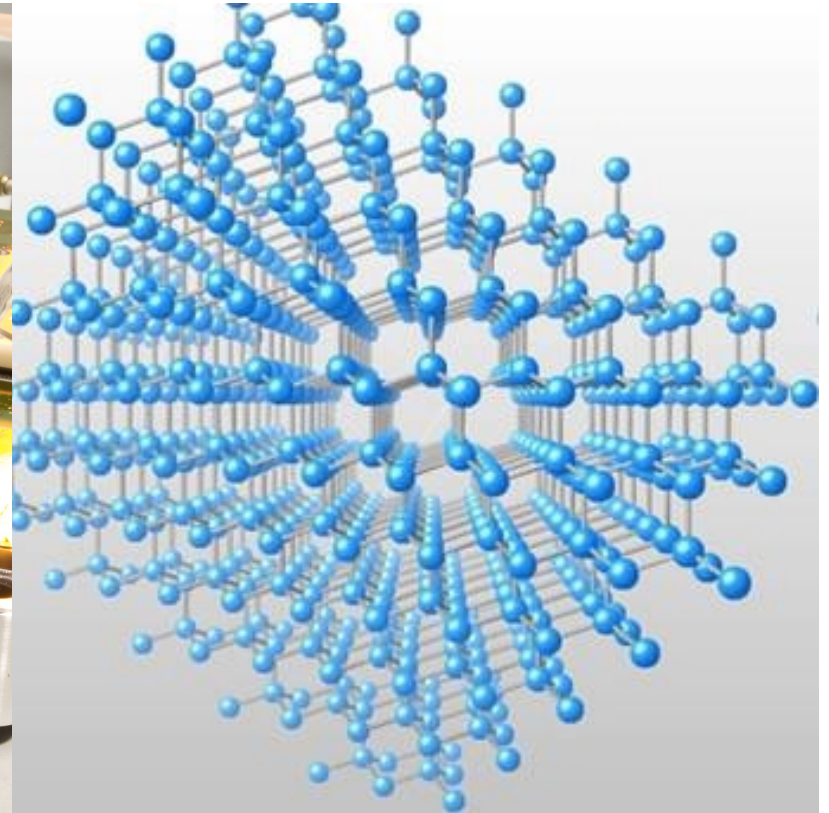
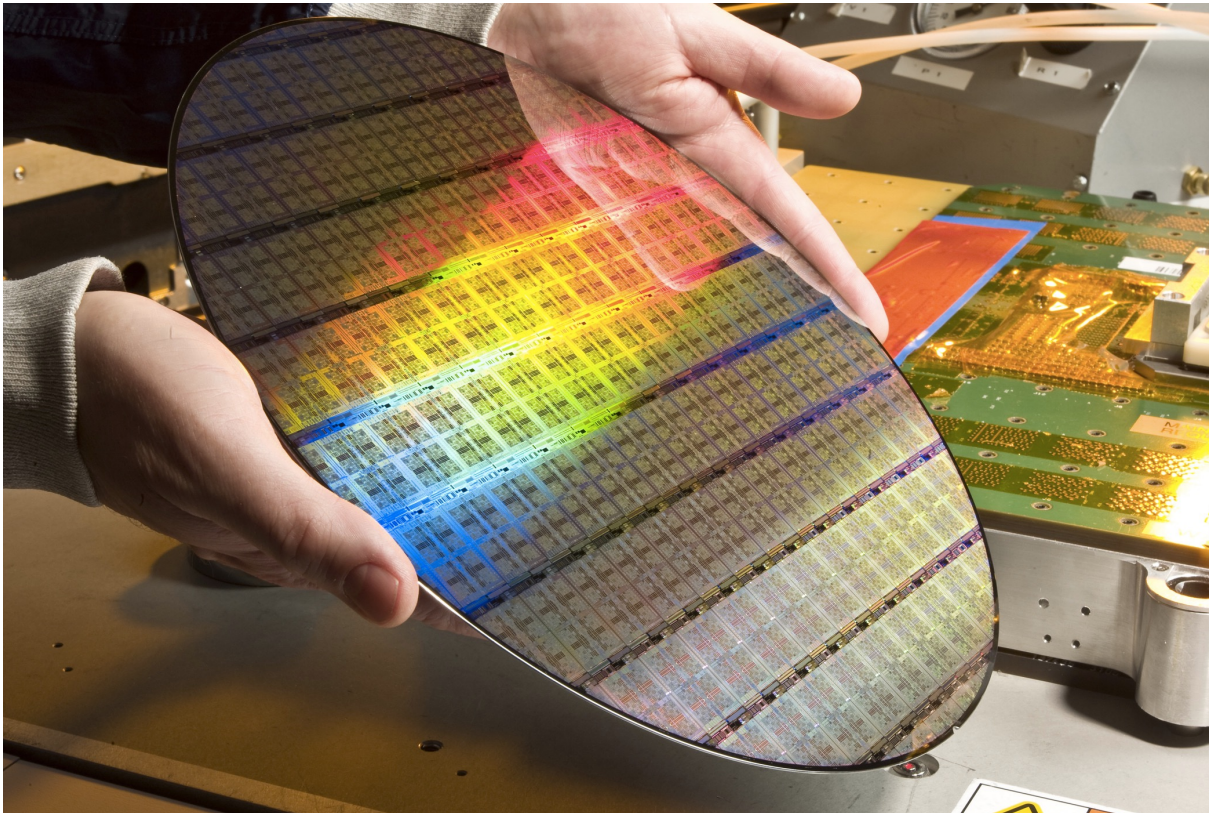
$$\rho = 3.2 \times 10^3 \, \Omega\text{m}$$



Silicon doped:

$$\rho = 4 \times 10^{-4} \, \Omega\text{m}$$

Ordered arrangement of the atomic structure:
crystalline structure



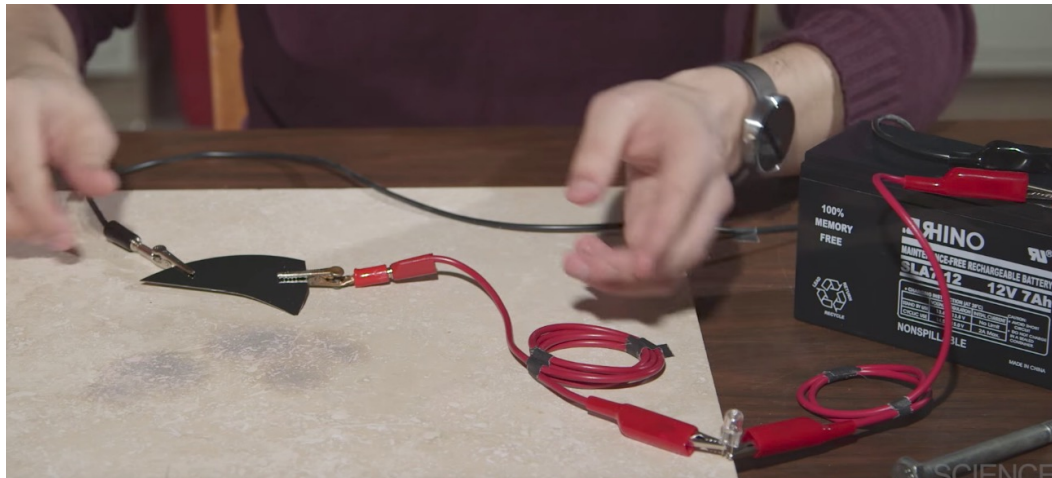
What is a semiconductor???

Compare Glass, Metal and Semiconductor

What is a semiconductor???

Compare Glass, Metal and Semiconductor

Silicon wafer

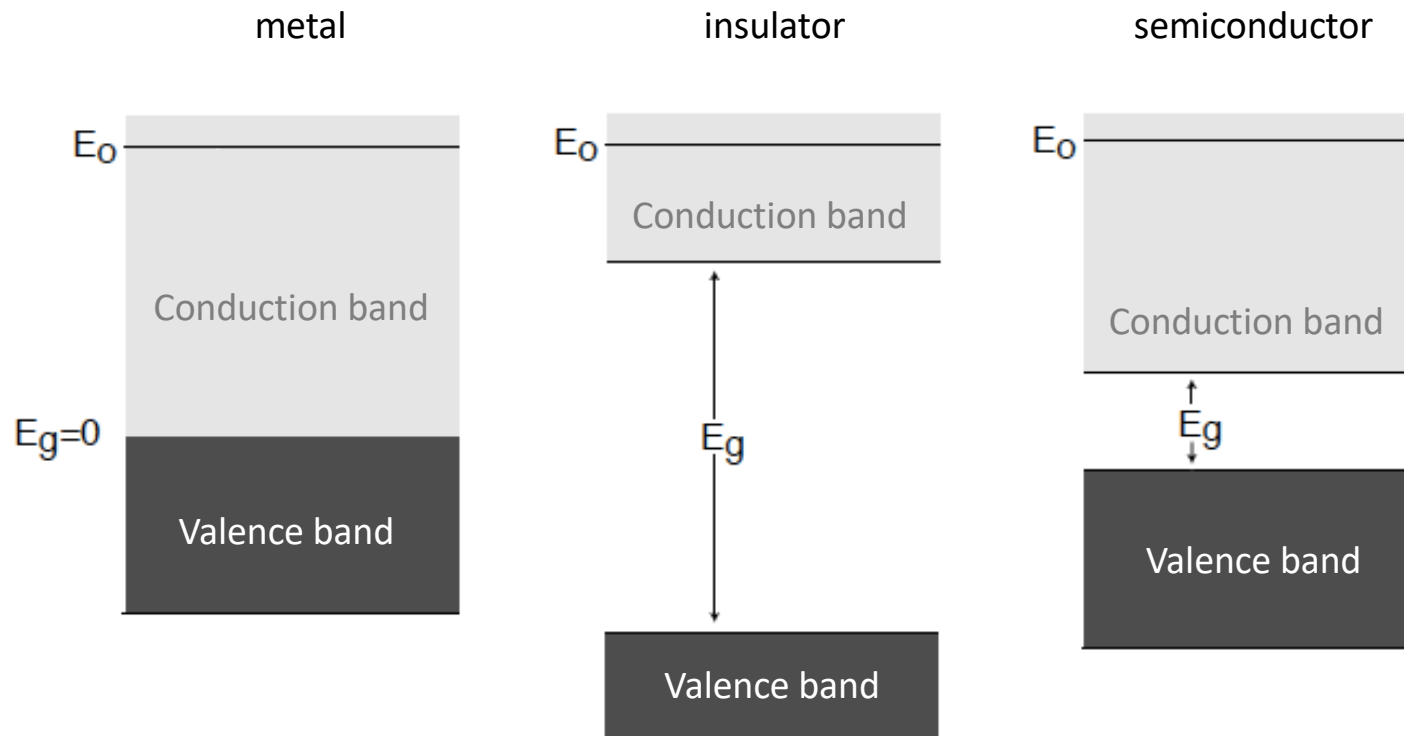


Silicon intrinsic:

$$\rho = 3.2 \times 10^5 \, \Omega \text{cm} = 3.2 \times 10^3 \, \Omega \text{m}$$



What is an energy bang gap E_g ?



What are semiconductor devices?

Transistor

The Nobel Prize in Physics 1956



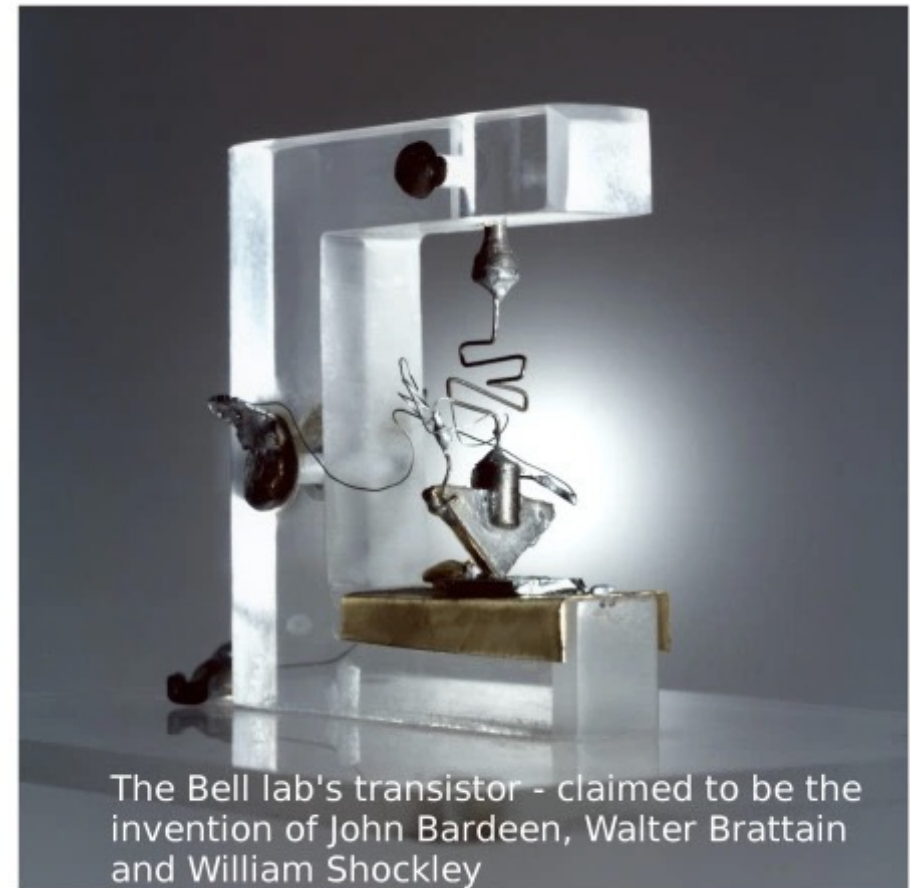
William Bradford
Shockley
Prize share: 1/3



John Bardeen
Prize share: 1/3



Walter Houser
Brattain
Prize share: 1/3

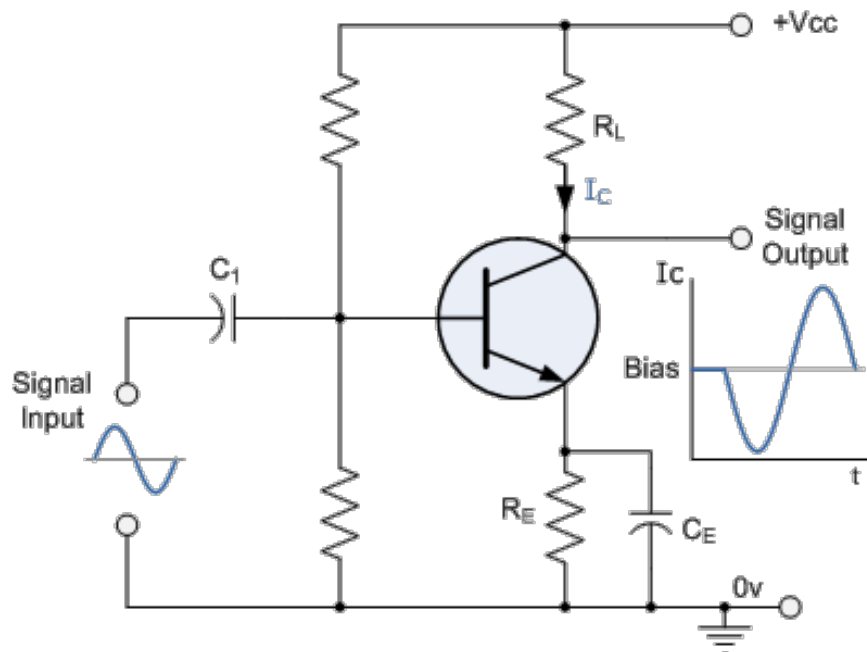


The Bell lab's transistor - claimed to be the invention of John Bardeen, Walter Brattain and William Shockley

What is so special about it?

What are semiconductor devices?

Transistor as amplifiers

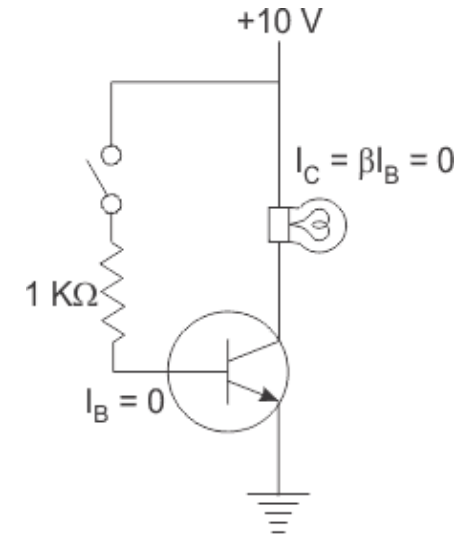
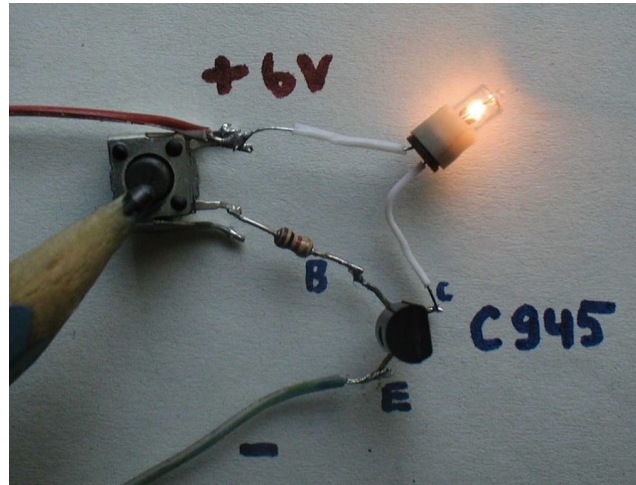


communications

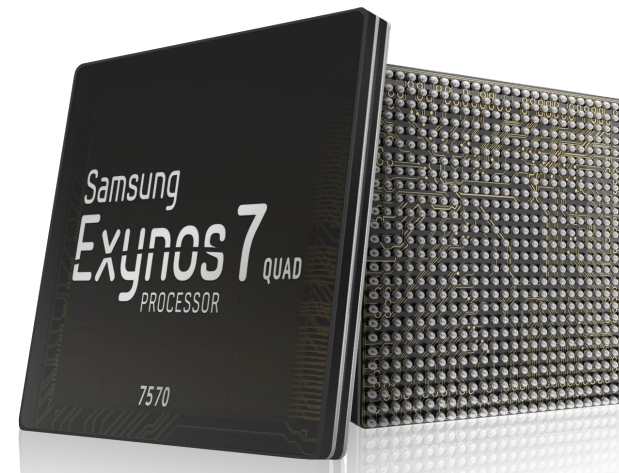
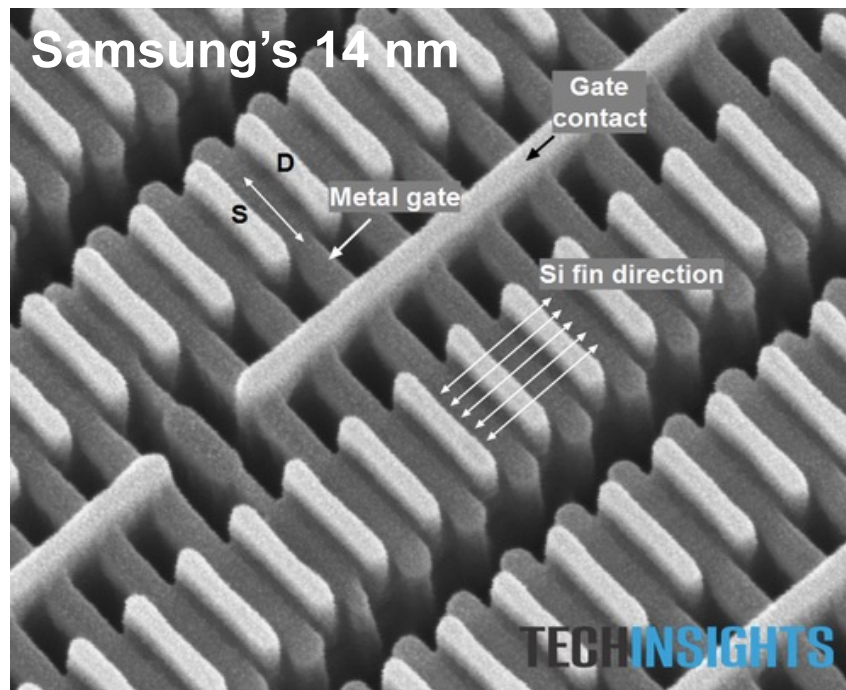


What are semiconductor devices?

Transistor as one switch



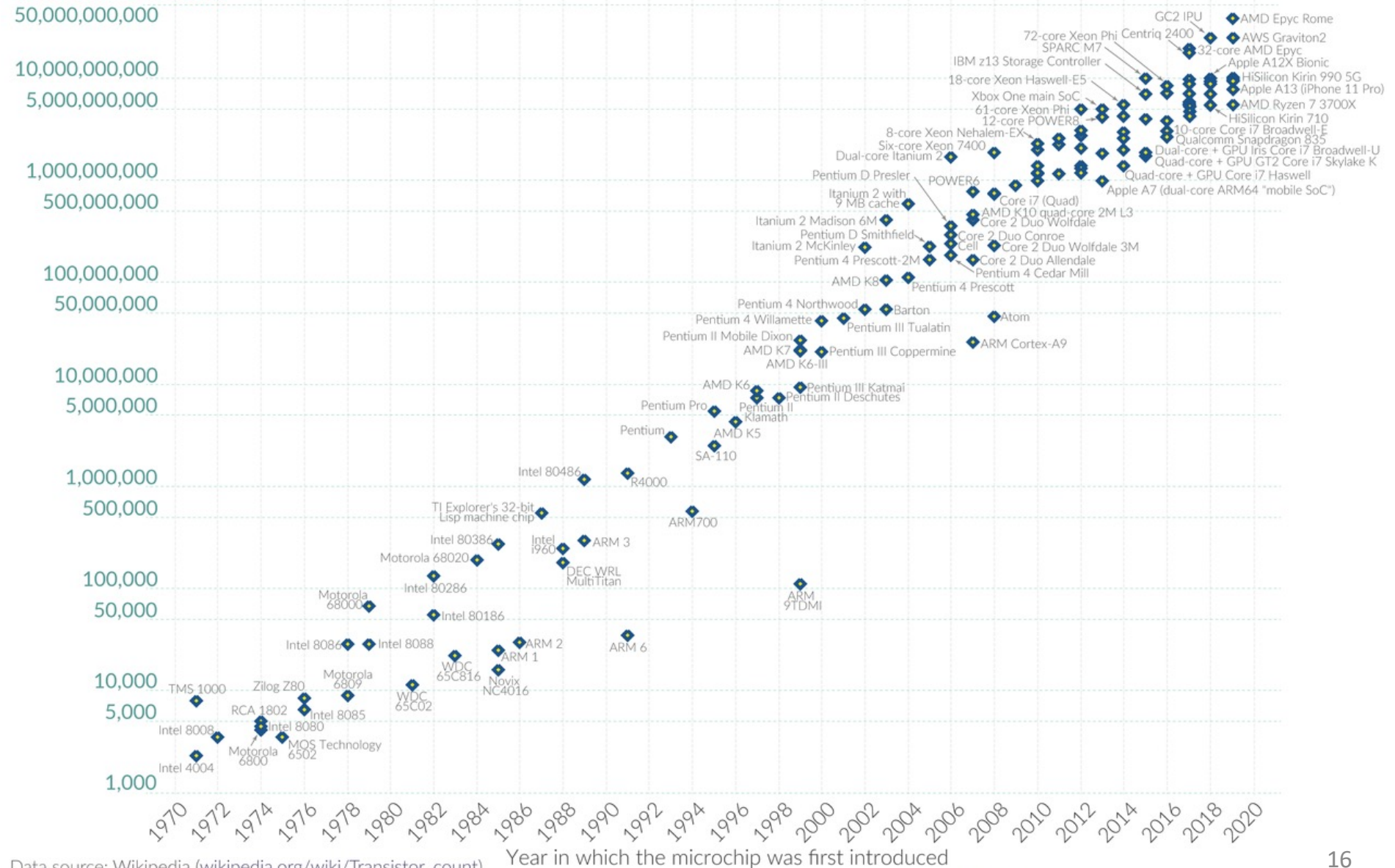
> 100 million transistors: microprocessor



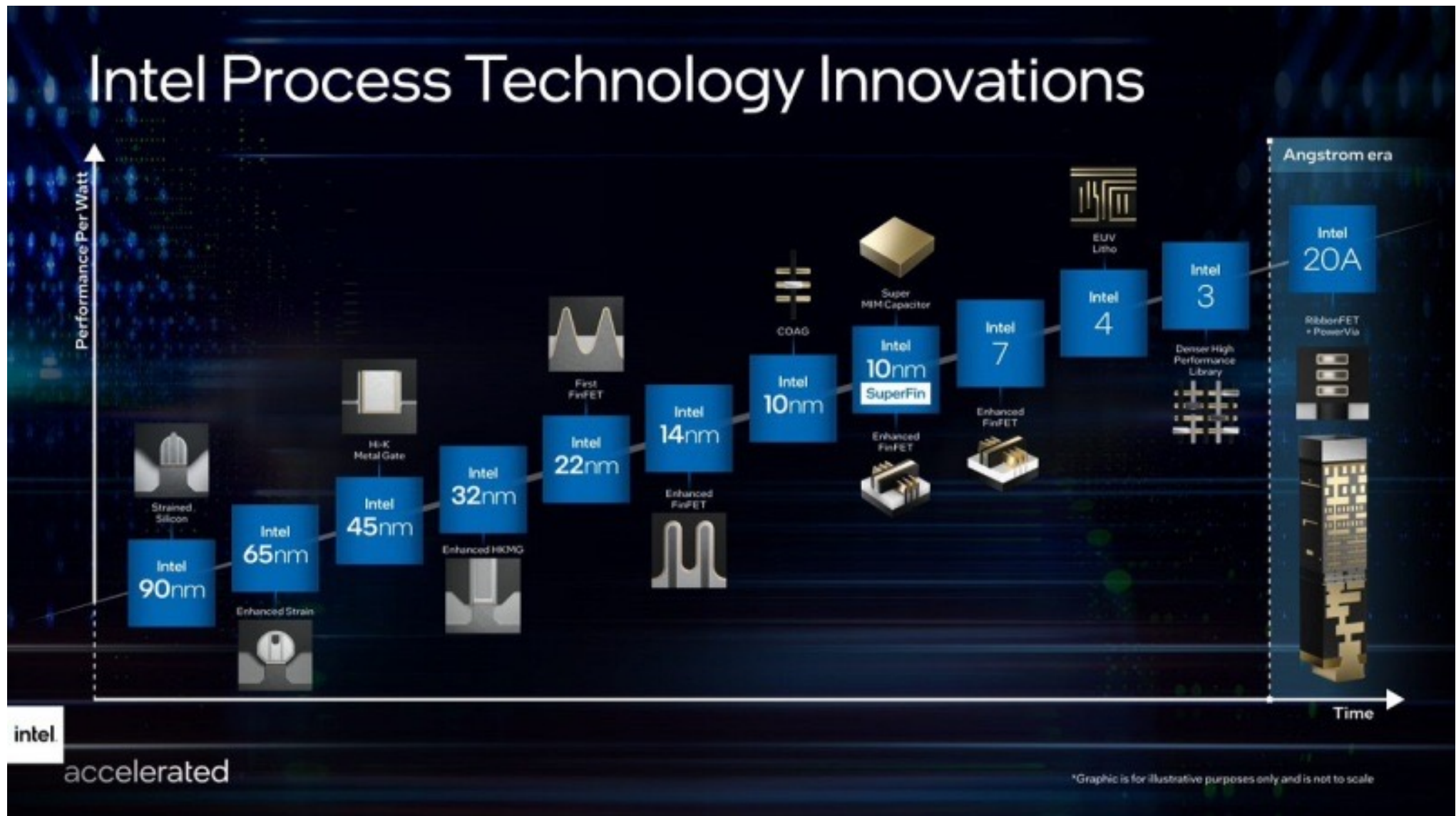
Moore's Law: The number of transistors on microchips doubles every two years

Moore's law describes the empirical regularity that the number of transistors on integrated circuits doubles approximately every two years. This advancement is important for other aspects of technological progress in computing – such as processing speed or the price of computers.

Transistor count



Why do we need new semiconductor physics/devices?

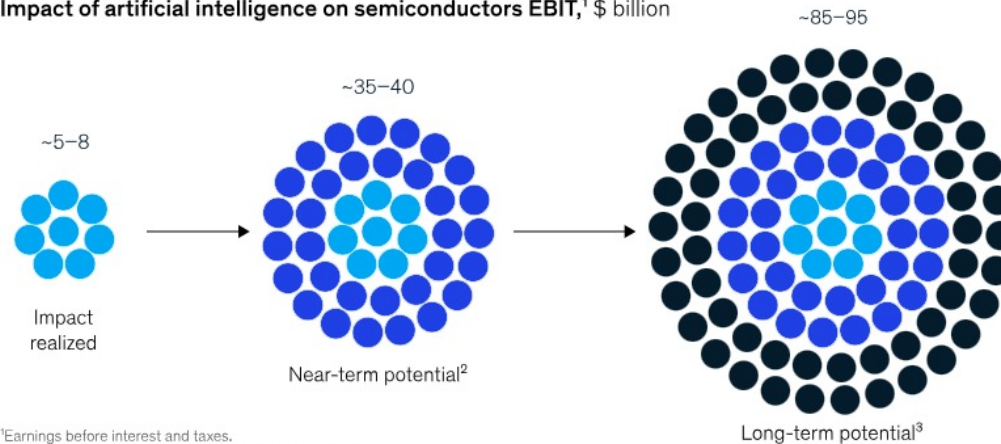


Each time the technology reached the predictive barriers...
imaginative new solutions were developed to further extend Moore's law

Why do we need new semiconductor devices?

Artificial intelligence could generate \$85 billion to \$95 billion for semiconductor companies over the long term.

Impact of artificial intelligence on semiconductors EBIT,¹ \$ billion



¹Earnings before interest and taxes.

²Near-term potential refers to gains within the next 2-3 years.

³Long-term potential refers to gains achieved 4 years or more in the future.

McKinsey
& Company

- Artificial intelligence
- Internet of things
- Automotive
- Communications
- renewables

Internet of things



Why do we need new semiconductor physics/devices?

Energy conversion

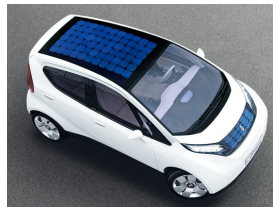
Wind turbines



Solar panels



Electric vehicles



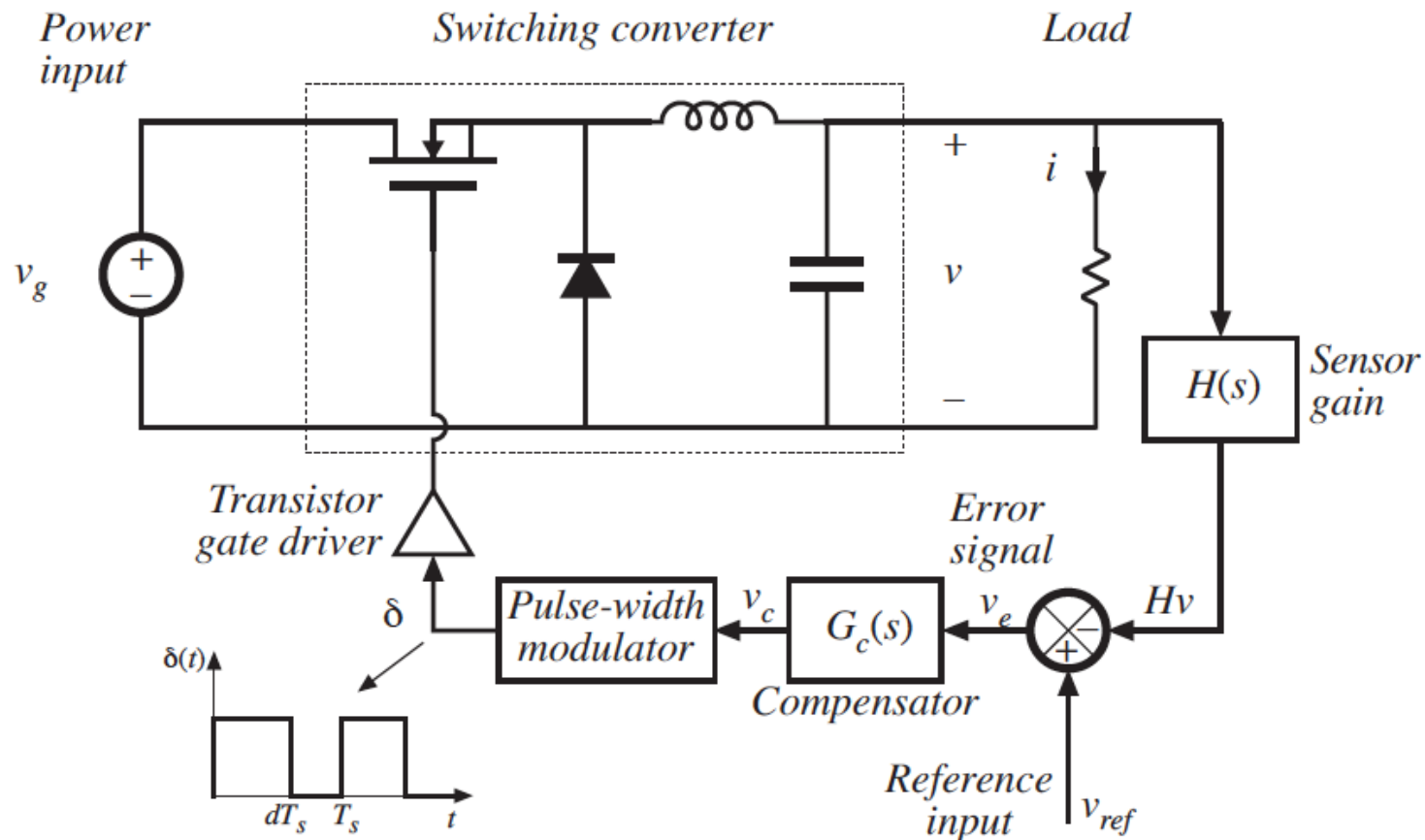
Data centers



LED light bulbs

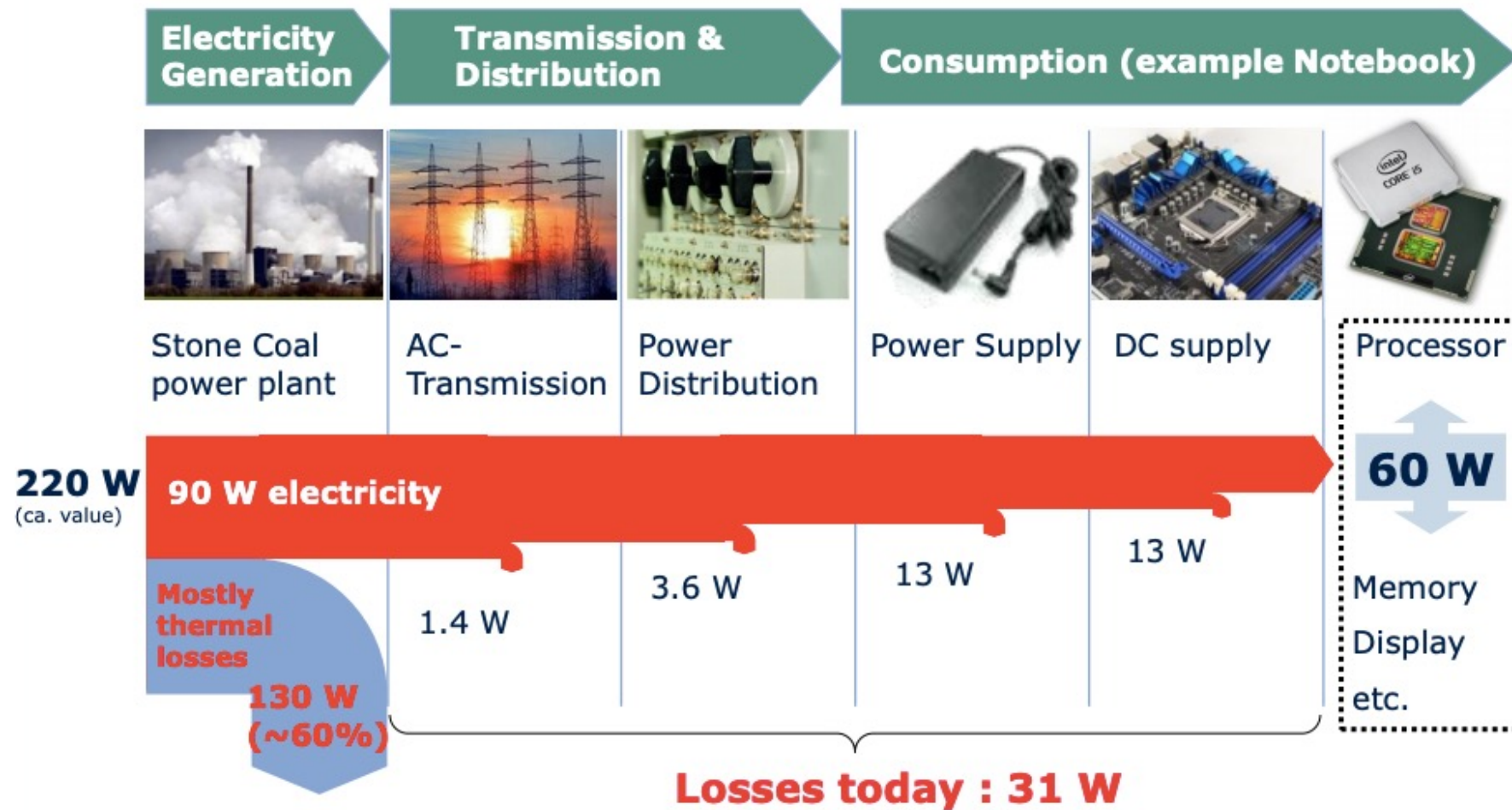


Power converter: Transistors + diodes + filters + control



In the case of high voltage converters, we need **power transistors and diodes**

Power Electronics: large potential for energy efficiency

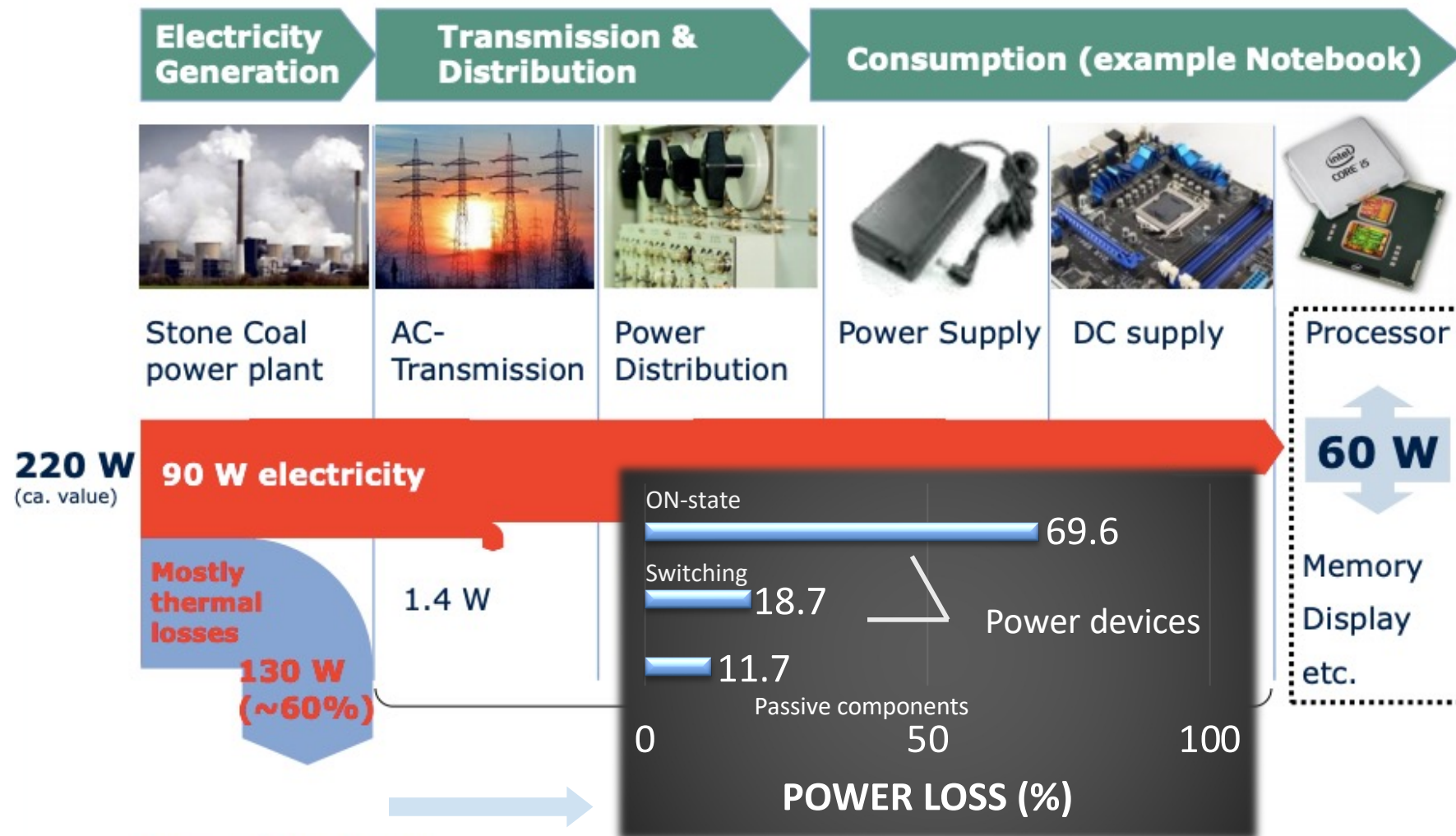


Source: Infineon estimate

[1] Infineon Technologies Austria AG, "GaN Power Devices: Development, Manufacturing, and Application," ICNS 2017, Strasbourg, France.

[2] O. Deblecker, Z. De Grève and C. Versèle, Comparative Study of Optimally Designed DC-DC Converters with SiC and Si Power Devices, Advanced Silicon Carbide Devices and Processing, 2015.

Power Electronics: large potential for energy efficiency



Source: Infineon estimate

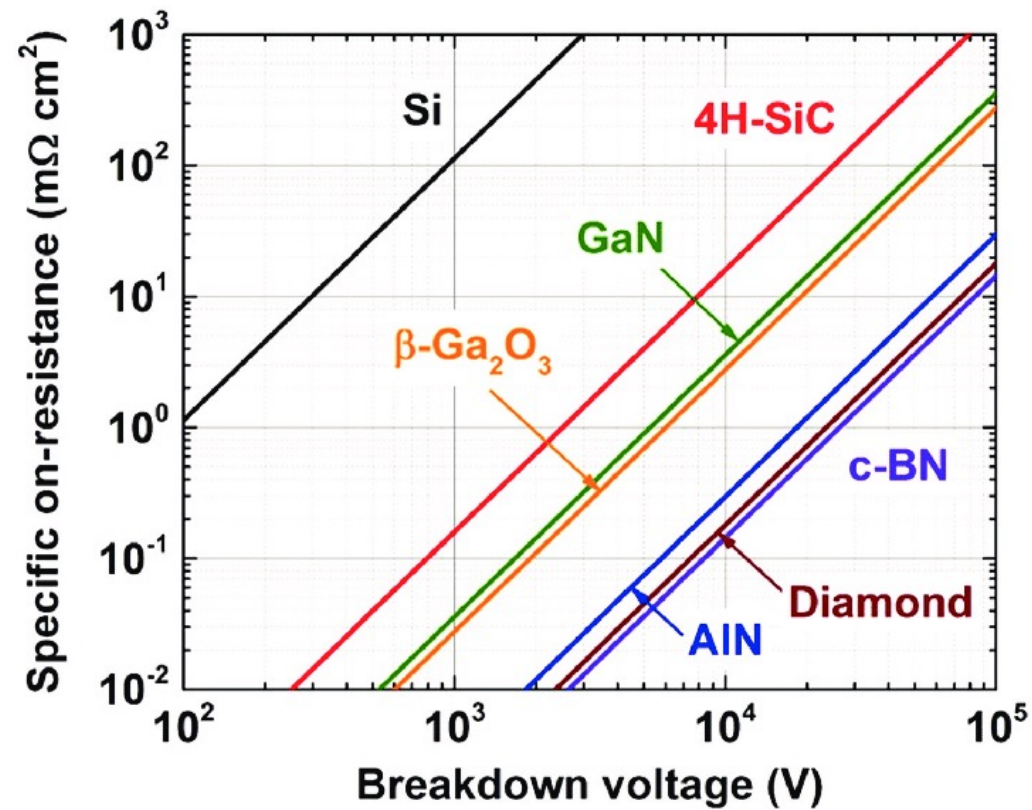
How to significantly reduce this losses?

[1] Infineon Technologies Austria AG, "GaN Power Devices: Development, Manufacturing, and Application," ICNS 2017, Strasbourg, France.

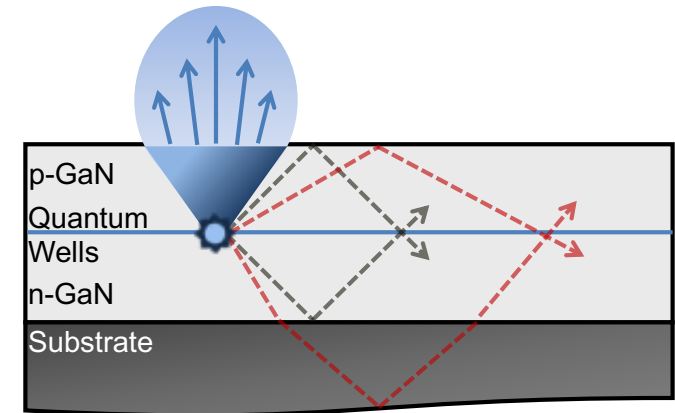
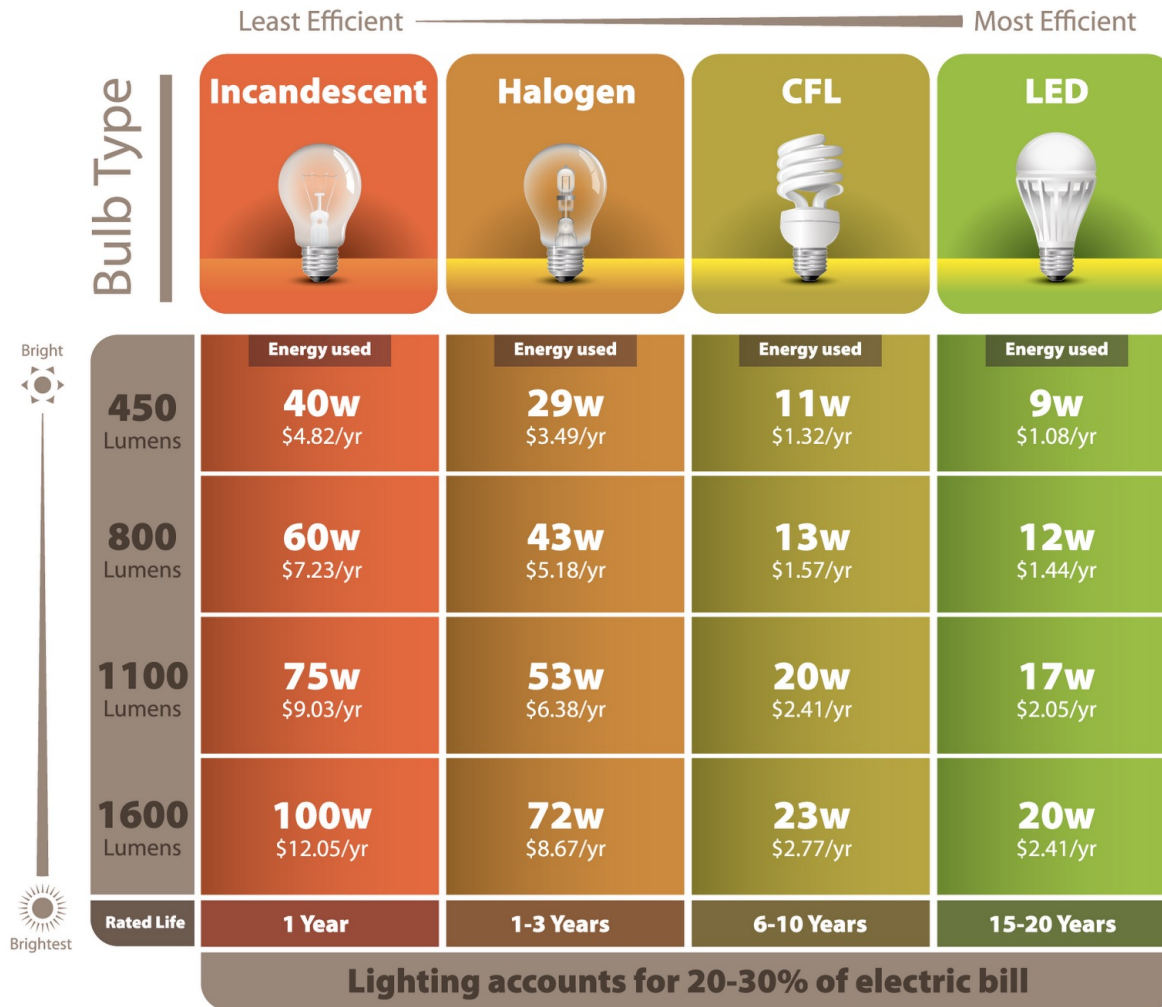
[2] O. Deblecker, Z. De Grève and C. Versèle, Comparative Study of Optimally Designed DC-DC Converters with SiC and Si Power Devices, Advanced Silicon Carbide Devices and Processing, 2015.

Semiconductors for POWER applications

What makes one material better than another?



Semiconductors also emit light: LED light bulbs



Nobel Prize in 2014

Prof. Shuji Nakamura
 Prof. Hiroshi Amano
 Prof. Isamu Akasaki



Why is that important?

European Chips Act

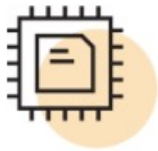
the EU will address semiconductor shortages and strengthen Europe's technological leadership. It will mobilise more than € 43 billion of public and private investments and set measures to prepare, anticipate and swiftly respond to any future supply chain disruptions, together with Member States and our international partners.



Strengthen Europe's research and technology leadership towards smaller and faster chips



Put in place a framework to increase production capacity to 20% of the global market by 2030



Build and reinforce capacity to innovate in the design, manufacturing and packaging of advanced chips



Develop an in-depth understanding of the global semiconductor supply chains



Address the skills shortage, attract new talent and support the emergence of a skilled workforce

Fabrication technologies:

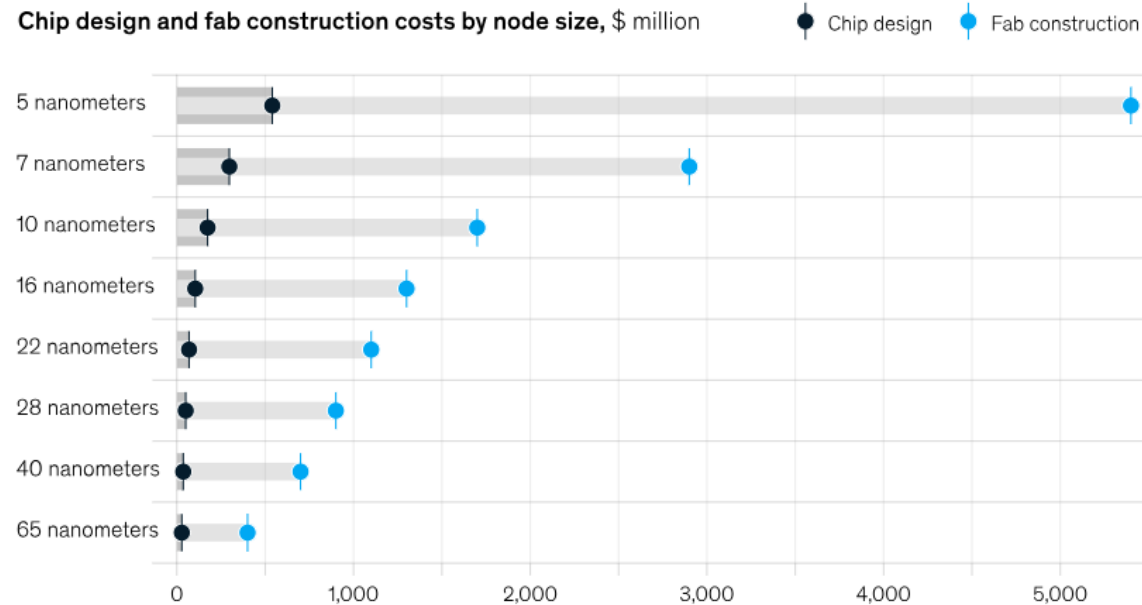
How do we convert a semiconductor into a transistor?

EE-557 - Semiconductor devices I

Fabrication technologies:

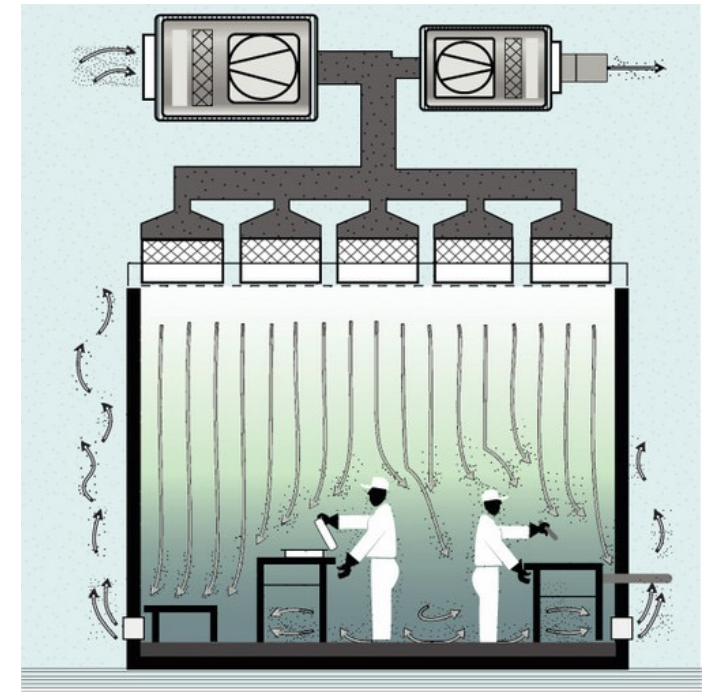
How do we convert a semiconductor into a transistor?

Costs for chip design and fab construction have soared as chips become increasingly complex.



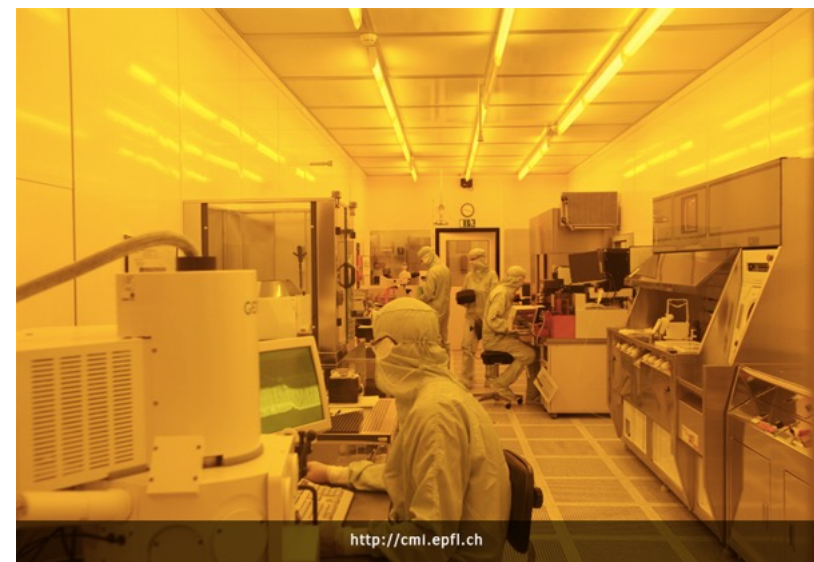
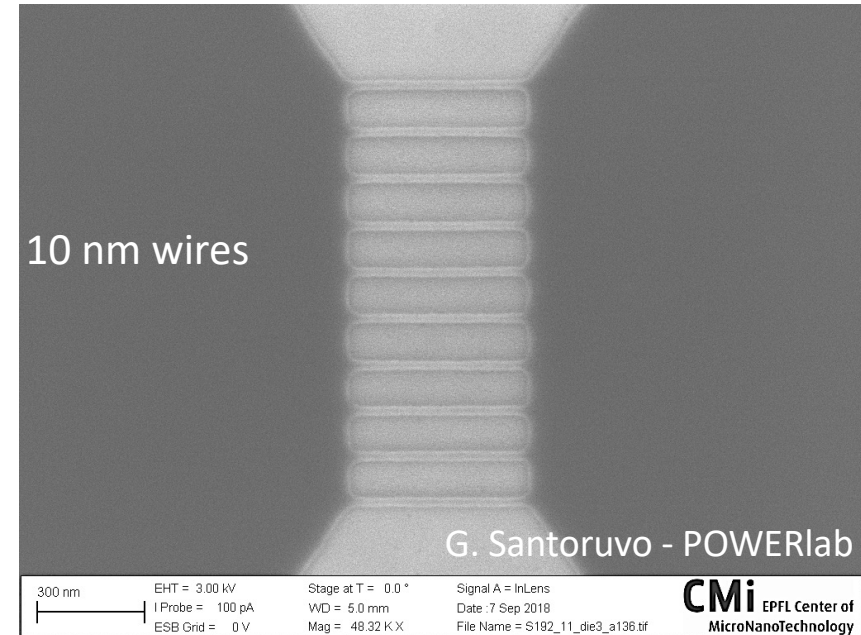
Source: IBS; McKinsey analysis

McKinsey
& Company



- Cleanrooms have controlled level of contamination:
 - Specified by the number of particles per cubic meter at a specified particle size.
- The ambient air outside 35,000,000 particles per cubic meter, 0.5 mm and larger in diameter
- Class 10 cleanroom has at most 352 particles of 0.5 um size in a cubic meter

Cleanroom at EPFL – class 100



Content of the course:

- Introduction to Semiconductors
- Carrier Generation and Recombination
- Optical properties
- Charge Transport
- Non-uniformly doped semiconductors
- p-n junctions
- Metal-semiconductor junctions
- Metal Oxide Semiconductor
- Power MOSFETs and devices

Documentation du module

- Course notes – Prof. E. Matioli (<http://moodle.epfl.ch>)
- J. A. del Alamo, Integrated Microelectronic Devices: Physics and Modeling, Pearson
- S. M. Sze and K. K. Ng, Physics of Semiconductor Devices, Wiley
- D. Schroder, Semiconductor Material and Device characterization, Wiley
- Extra required documents will be announced during classes

How to take advantage of this course:

- **The material for the course will be made available on moodle before each class;**
- **I will try to register each lecture in video and upload them (not guaranteed). You will benefit a lot more by coming to class.**
- **There will be more resources to read posted on moodle than what is covered in class:**
Read from the text book at least the topics covered in class
- **The physical text book is available in the library:**

J. A. del Alamo, Integrated Microelectronic Devices: Physics and Modeling, Pearson

Class structure:

14 weeks – 4 lectures of 45 minutes per week: 56 lectures

38 theoretical lectures

14 exercise lectures – grouped in 7 lectures of 1h30 (in red in the syllabus)

2 exam sessions fo 1h30 : 1 mid-term and 1 final

Class are on:

mondays 15h-17h MEB 331

wednesdays 10h-12h BS160

Starts at 15 min after the hour and finishes at the hour

Evaluation :

- **Mid-term exam: Nov. 6th 2024 (40%)**
- **Final Exam: Dec. 18th 2024 (60%)**

Syllabus (on moodle)



EE 557 - Semiconductor Devices I

Date	lecture number	title	content
09.09.2024	1	Introduction	Introduction to the class: final goal what is a semiconductor? Examples: data processing, energy conversion, LEDs Introduction to lab, master and semester projects
11.09.2024	2	Band structure	Crystal lattice, energy bands Band Diagram
16.09.2024	3	Density of States and carrier density	Density of States Carrier Statistics Effective mass
18.10.2024	4 EX1	Doping	Doping intrinsic and extrinsic equilibrium concentration np product, Fermi level ionization
23.09.2024	5	Exercise 1	
25.09.2024	6	Carrier Generation and Recombination	Introduce phonons, electrons and photons Recombination, Generation, Lifetime Generation and recombination - light pulse
30.09.2024	7	Optical properties	Silicon solar cells LEDs
02.10.2024	8	Charge Transport	thermal velocity Carrier transport: drift and diffusion Set of equations Diffusion
07.10.2024	9 EX2	Non-uniformly doped semiconductors and quasi Fermi levels	Non-uniformly doped semiconductors Quasi-Fermi levels
09.10.2024	10	Exercise 2	
14.10.2024	11	Carrier flow - Schokley equations	
16.10.2024	12	p-n junctions (half of the content)	introduction (solar cells, LEDs, diodes) p-n junctions in TE
28.10.2024	13 EX3	pn junctions (finish)	p-n junctions under bias
30.10.2024	14	non-idealities and switching behavior	
04.11.2024	15	Exercise 3 - before exam (solve midterm)	Solve Exercises 3 in the black board (Quasi fermi levels) switching characteristics
06.11.2024	16	mid term	
11.11.2024	17	Mid-term correction	
13.11.2024	18	Metal semiconductor junctions	Schottky Schottky barrier: measurement band line up
18.11.2024	19 EX4	Schottky and Ohmic contacts	Schottky diodes - devices Ohmic: TLM exercises Schottky
20.11.2024	20	Metal Oxide Semiconductor	MOS capacitors interface traps
25.11.2024	21	Metal Oxide Semiconductor and its dynamics	MOSFETs Three terminal MOSFET - 1st class
27.11.2024	22	Exercise 4	
02.12.2024	23 EX5	MOSFETs	mosfets dynamic performance Dynamic and CV mobility and inversion layer
04.12.2024	24	Power devices	basics of power devices Baliga's figure of merit Power diodes Power MOSFETs
09.12.2024	25	Exercise 5	
11.12.2024	26	Advanced concepts	
16.12.2024	27	Revision / Exercises / Questions	
18.12.2024	28	Finals	

Class structure:

- 38 theoretical lectures in class (in black)
- 14 exercise lectures – grouped in 7 lectures of 1h30 (in red)
- 2 exam sessions of 1h30 : 1 mid-term and 1 final (in blue)
- I will have conferences abroad during 2 dates (in yellow), a replacement video will be uploaded (and/or a replacement TA will be announced)

A little about me:

Ecole Polytechnique Fédérale de Lausanne (EPFL)
Professor - Institute of Electrical Engineering (STI)



Massachusetts Institute of Technology, USA
Electrical Engineering and Computer Science (EECS)



University of California, Santa Barbara USA
Ph.D., Materials Science



Ecole Polytechnique, France Promotion X2002
B.Sc. - Applied Physics / Applied Mathematics



III-Nitrides are an exceptional material

Lighting

Displays



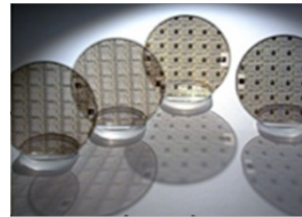
Light bulbs



electric automobiles



Nitrides Semiconductors



Power electronics

Wireless Communications

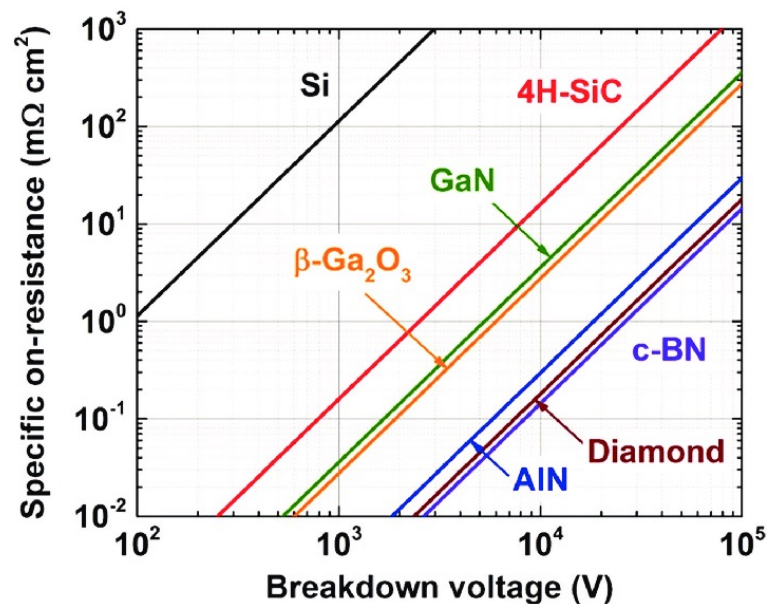
RF power amplifiers



Power converters



Drivers / Inverters



Optoelectronics:

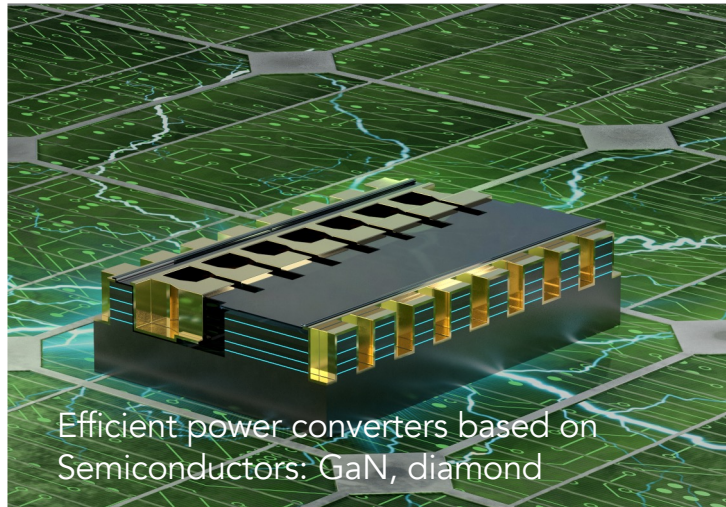
- High internal quantum efficiency: LEDs
- Polarized light emission: displays
- Tunable direct band gap: solar cells

Electronics:

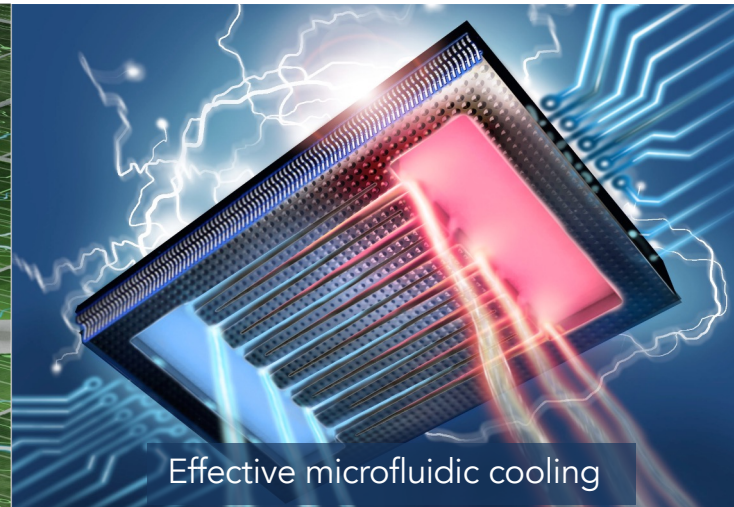
- High electron velocity (×3 than Si)
- High carrier density (×3 than Si)
- High breakdown voltage (>×10 than Si)

POWERlab@EPFL - Our activities

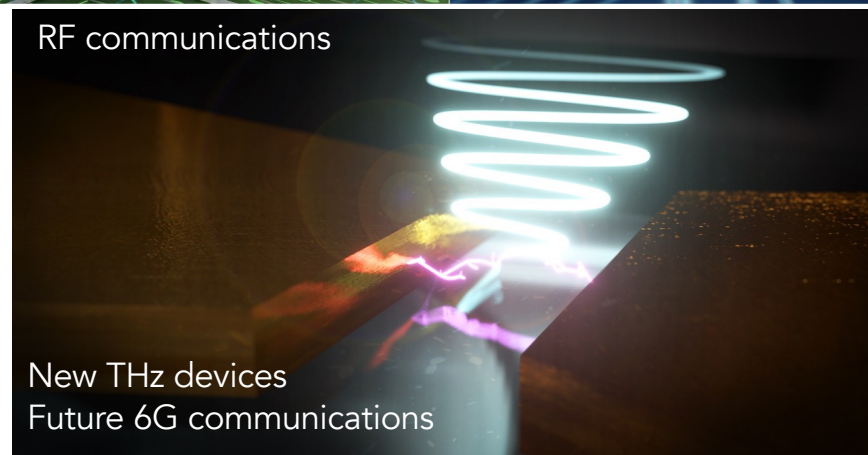
Power semiconductors



Cooling of electronics



RF communications

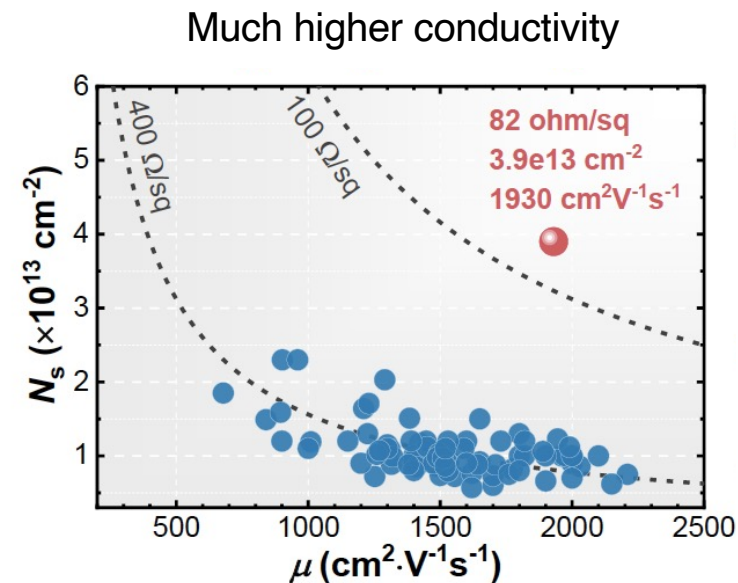
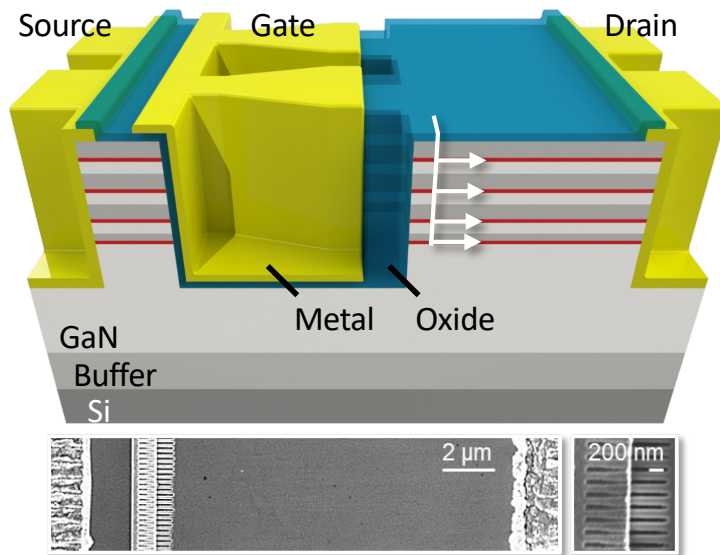


Snapshot of our laboratory:

I. Nanostructure for power electronic devices

Multi-channel power devices for ultra-low resistance and high breakdown voltage

1. Multiple 2DEG channels



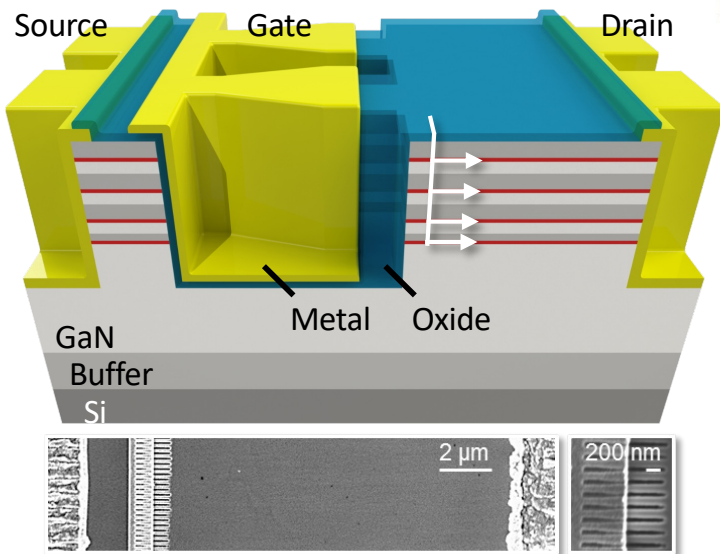
More than 5x-higher conductivity: significantly lower resistive losses!

Snapshot of our laboratory:

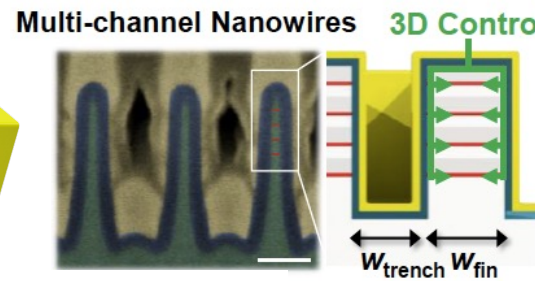
I. Nanostructure for power electronic devices

Multi-channel power devices for ultra-low resistance and high breakdown voltage

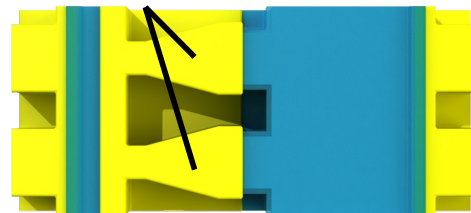
1. Multiple 2DEG channels



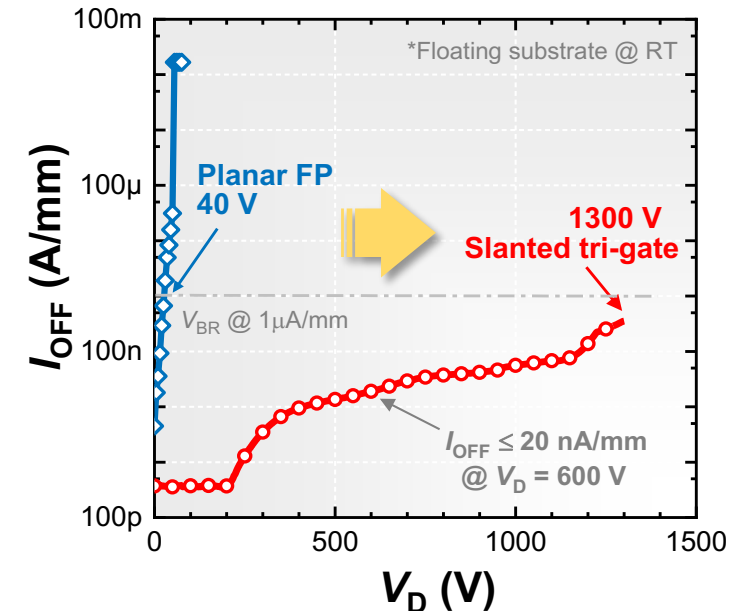
2. Tri-gate control



3. Slanted tri-gate termination



High breakdown voltage of 1300 V

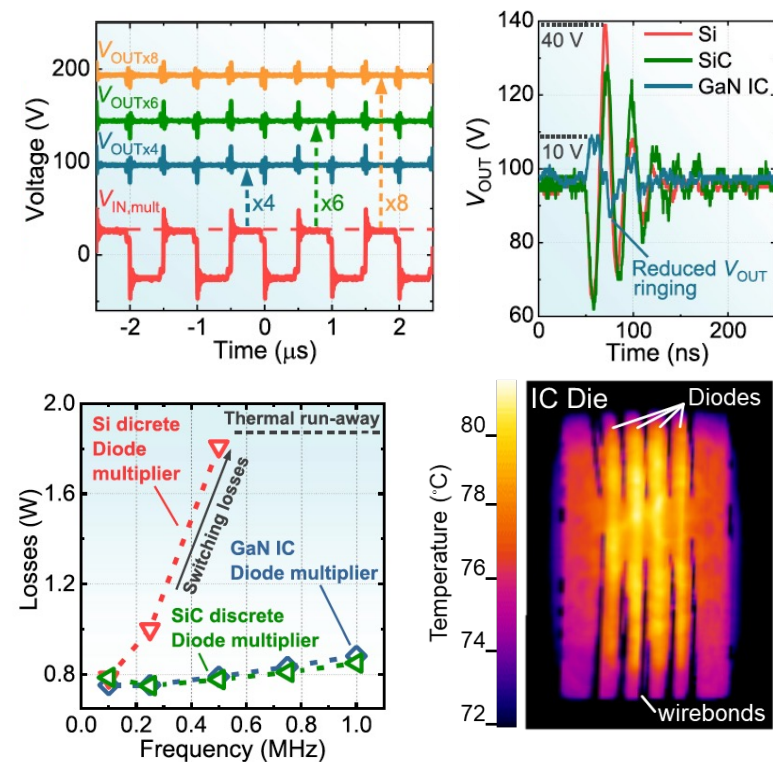
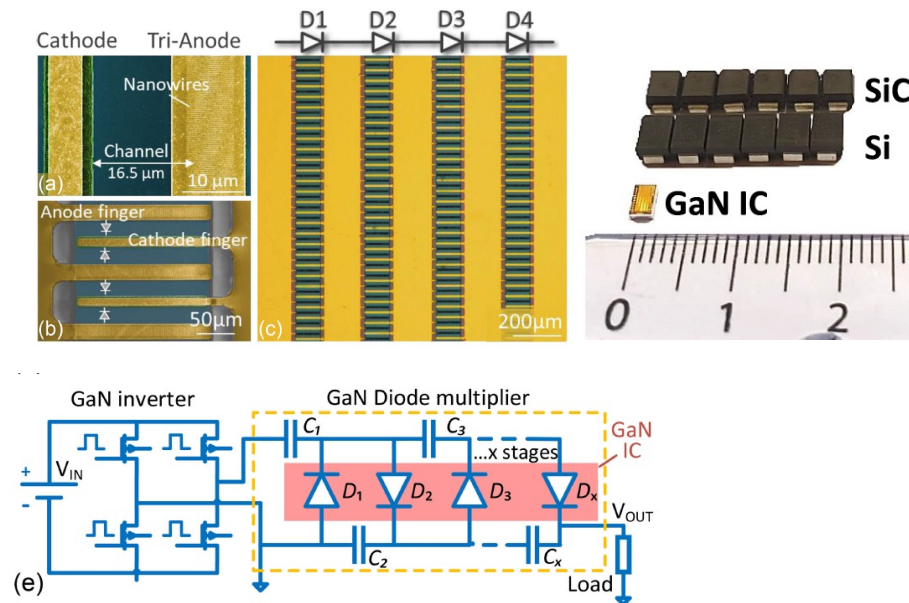


3D geometry increased the breakdown voltage from 40V to 1300V

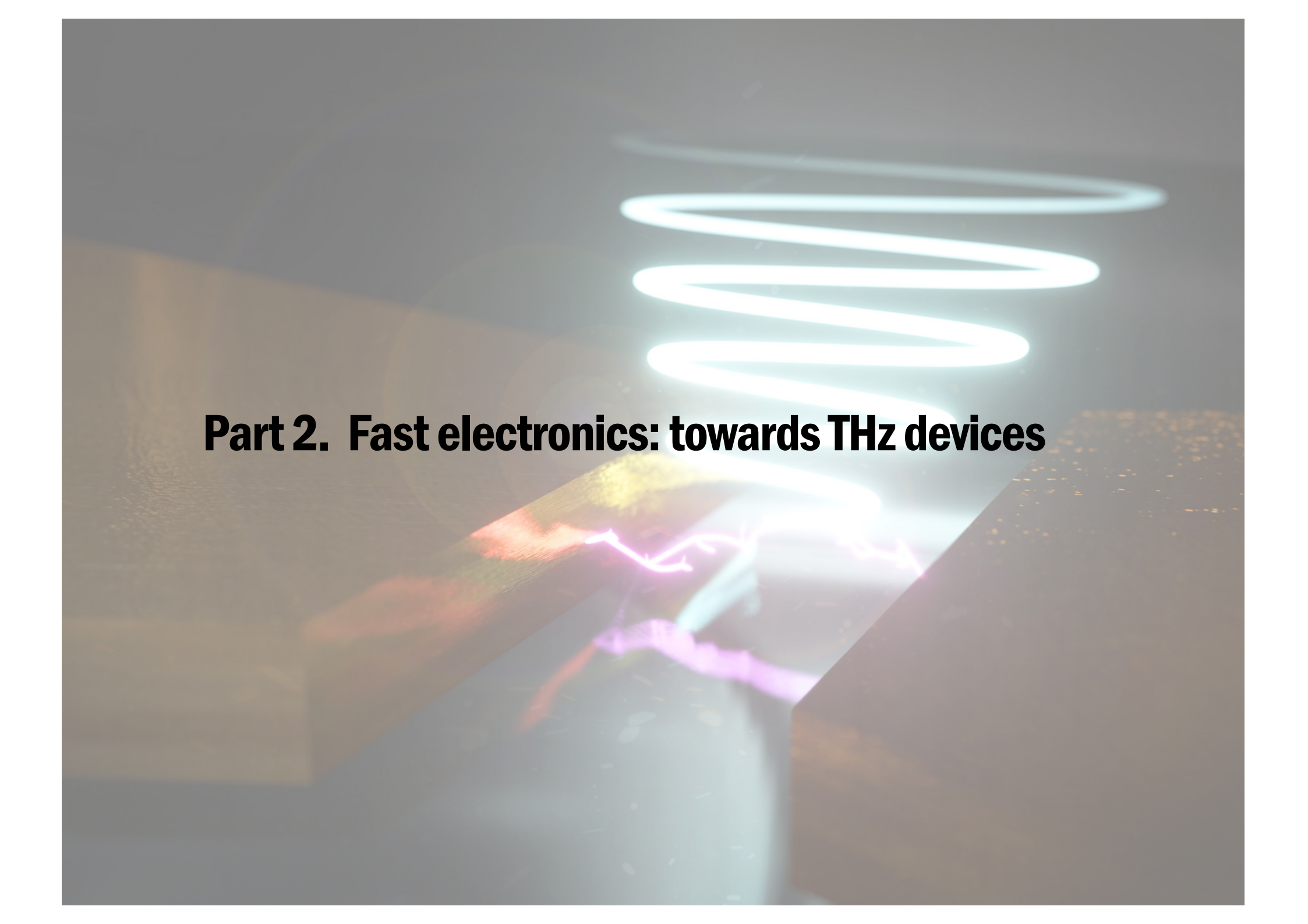
- J. Ma, C. Erine, M. Zhu, L. Nela, K. Cheng, E. Matioli, 2019 **IEEE International Electron Devices Meeting (IEDM)**, San Francisco, 2019
- L. Nela, J. Ma, C. Erine, P. Xiang, T.-H. Shen, V. Tileli, K. Cheng, E. Matioli, **Nature Electronics**, 2021
- J. Ma, G. Kampitsis, P. Xiang, K. Cheng and E. Matioli, **IEEE Electron Device Letters**, 2018.
- J. Ma, C. Erine, P. Xiang, K. Cheng and E. Matioli, **Applied Physics Letters**, 2018.

Snapshot of our laboratory: Integrated GaN-on-Si Schottky diodes

Diode voltage multiplier GaN IC

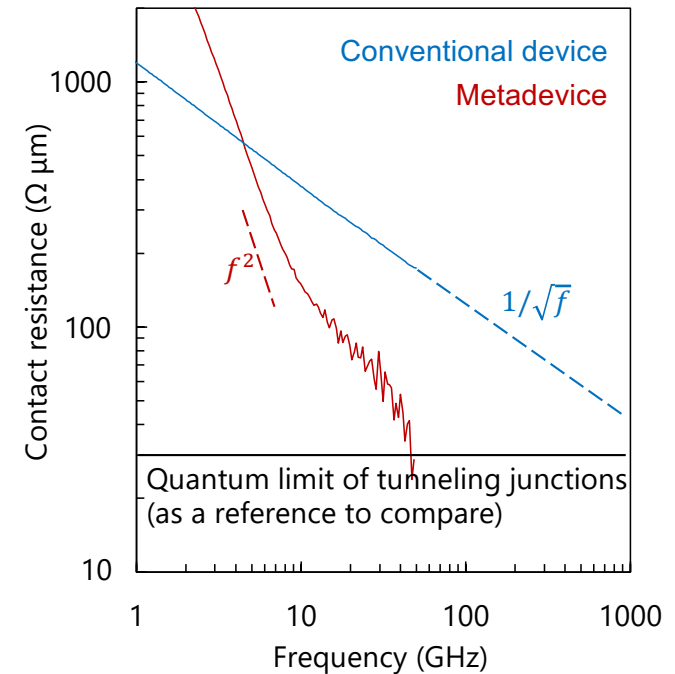
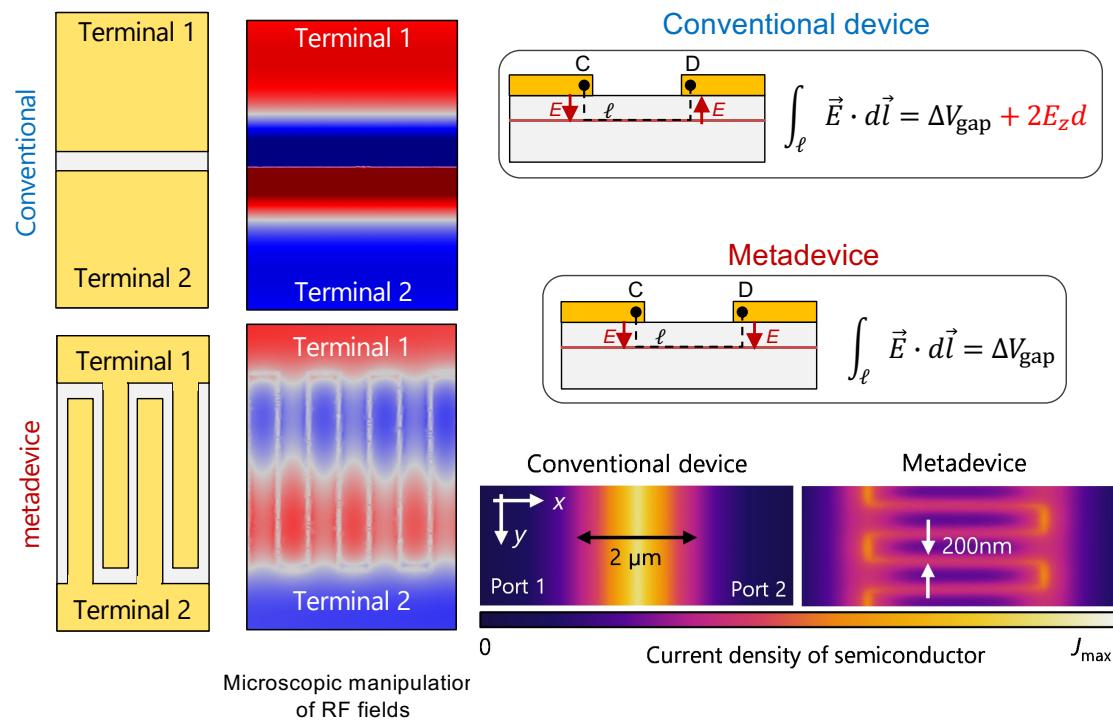


High frequency switching in GaN integrated devices: small devices and energy storage elements



Part 2. Fast electronics: towards THz devices

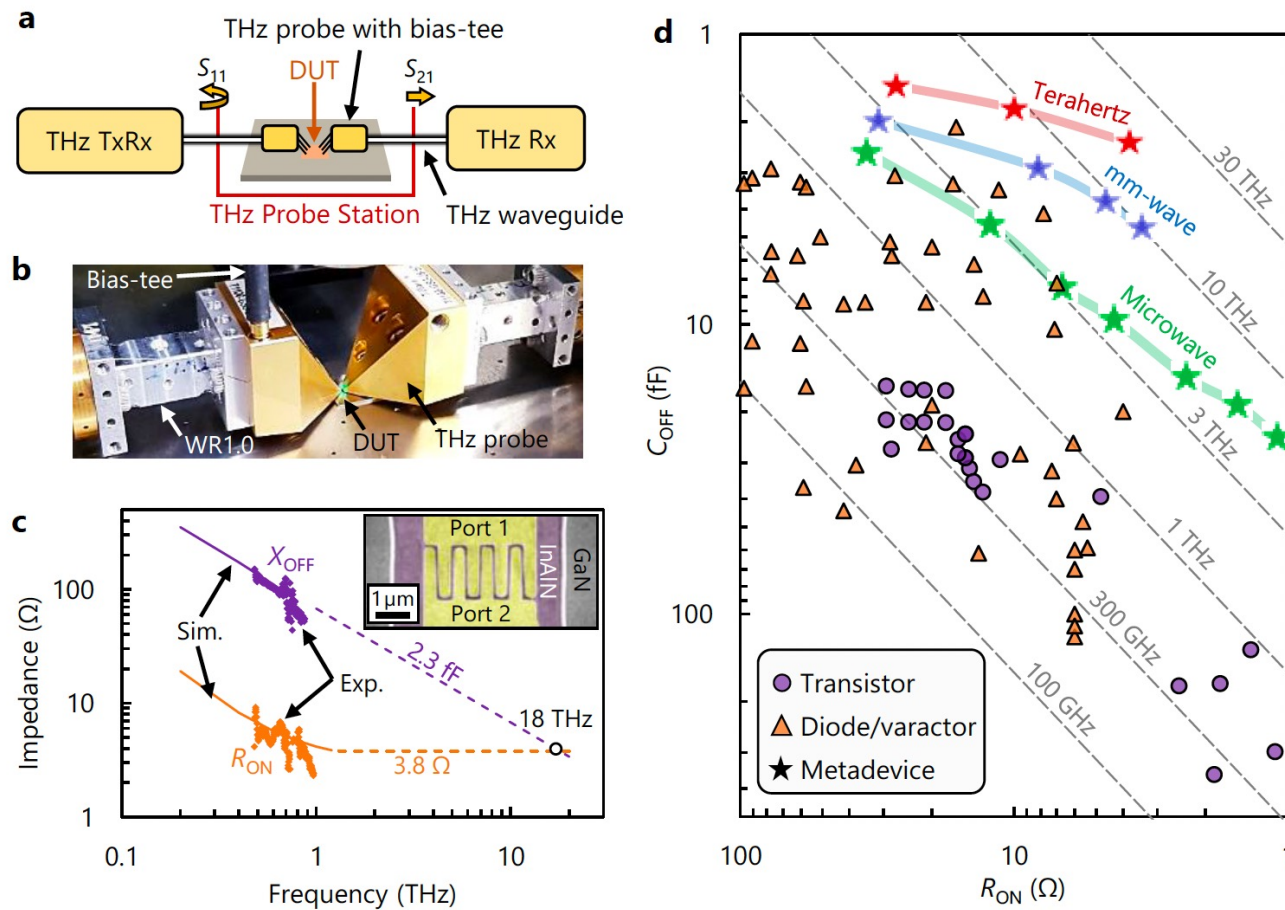
Snapshot of our laboratory: Microscopic manipulation of RF fields



Elison Matioli

Replacing the straight-gap by a stripe array, enhances the conductance of the device

Snapshot of our laboratory: Electronic metadevices for THz

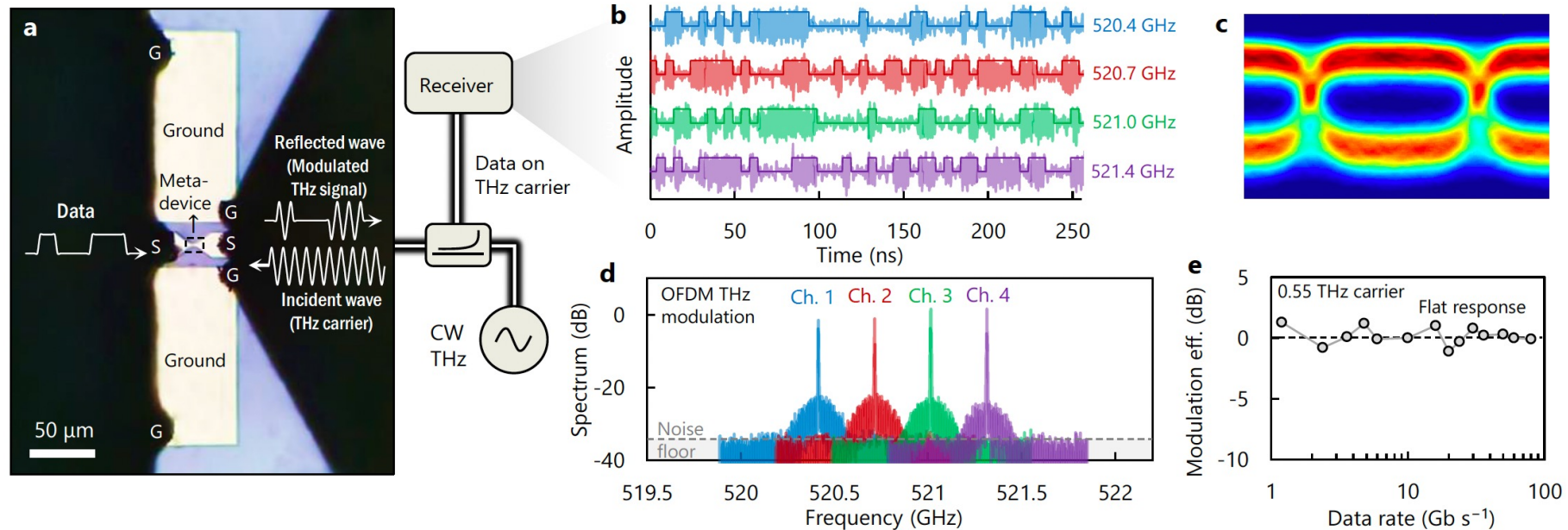


M. Samizadeh and E. Matioli, *Electronic Metadevices for terahertz applications*, **Nature** (2023)

Snapshot of our laboratory: Electronic metadevices for THz

nature

Electronic metadevices for terahertz applications



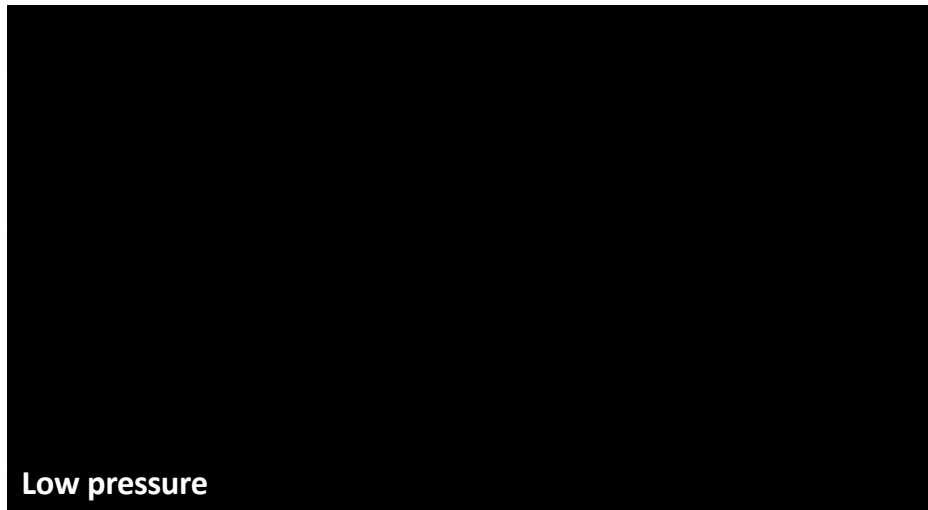
High-performance THz data transmitters using electronic metadevices

M. Samizadeh and E. Matioli, *Electronic Metadevices for terahertz applications*, **Nature** (2023)

Part 3. Managing ultra high power density:
Microfluidic cooling of electronics

Snapshot of our laboratory: Near-junction microfluidic cooling

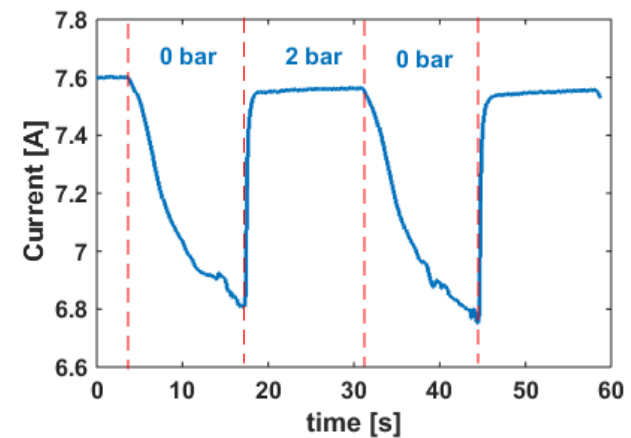
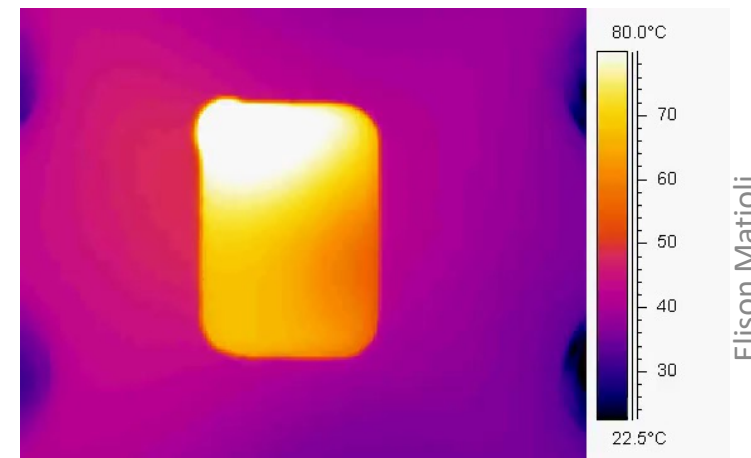
45



R. van Erp, G. Kampitsis, L. Nela, R. Soleimanzadeh and E. Matioli, *Nature*, 2020.

All devices were fabricated at the
EPFL cleanroom facilities (CMI)

CMI EPFL Center of
MicroNanoTechnology



Snapshot of our laboratory: Fully-integrated power IC with microfluidic cooling

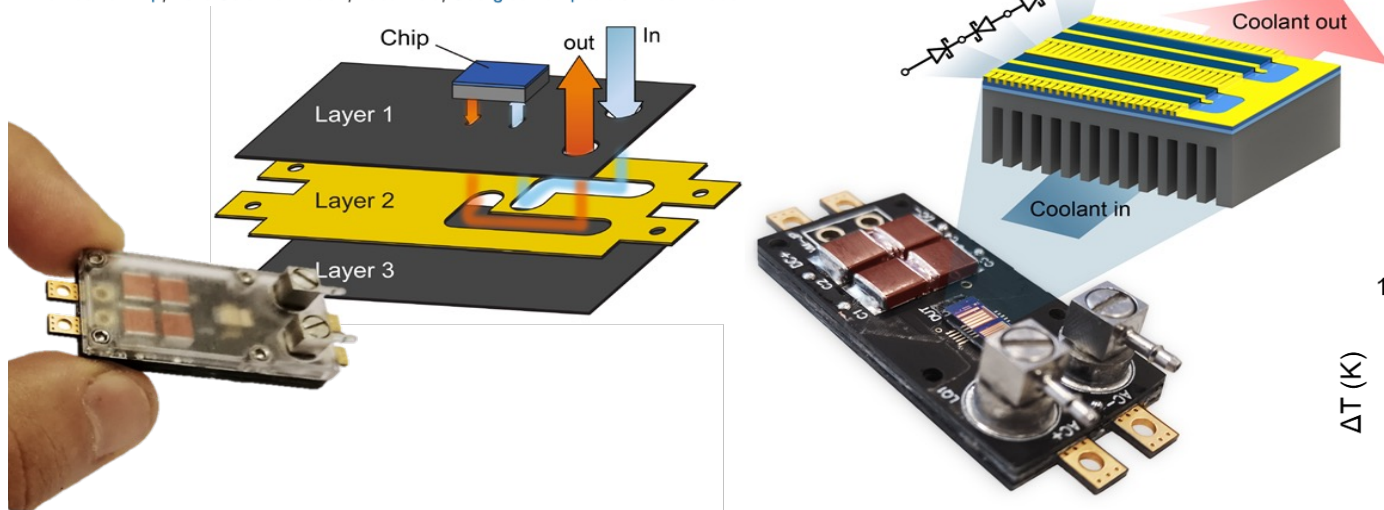
46

nature

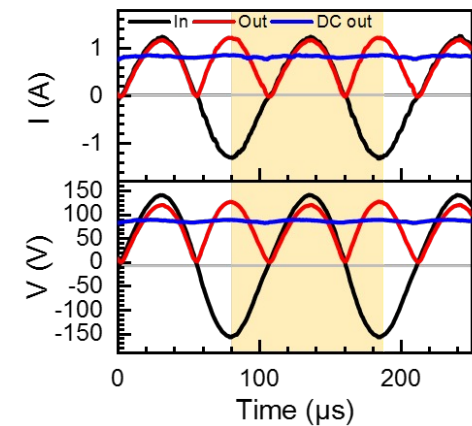
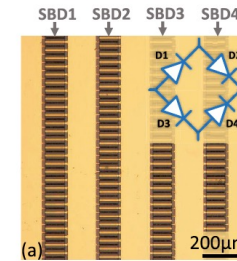
Article | Published: 09 September 2020

Co-designing electronics with microfluidics for more sustainable cooling

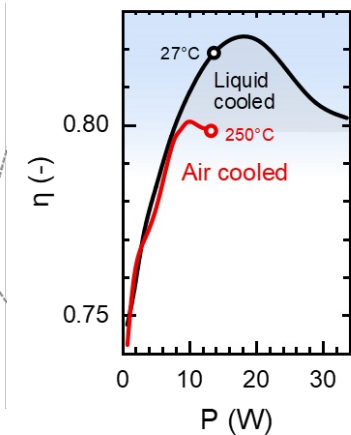
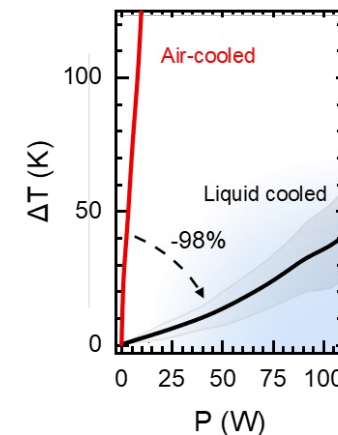
Remco van Erp, Reza Soleimanzadeh, Luca Nela, Georgios Kampitsis & Elison Matioli



Efficient thermal management enables integration of power devices for high power density applications



Elison Matioli



R. van Erp, R. Soleimanzadeh, L. Nela, G. Kampitsis and E. Matioli, *Nature* 585 (7824), 211-216 (2020).

L. Nela, R. Van Erp, G. Kampitsis, H. K. Yildirim, J. Ma and E. Matioli, *IEEE Transactions on Power Electronics*, vol. 36, no. 2, pp. 1269-1273, Feb. 2021

Bachelor and Masters Projects



The POWERlab offers several projects for EPFL students, at the bachelor and master levels, to work closely with our Ph.D. students and postdocs. Below is the list of available projects:

Bachelor and Master Semester Projects:

Master Thesis (30 ECTS credits)

There are several projects available for Master thesis for EPFL students. Please contact Prof. Mاتيoli to discuss in more details.

If you are interested and would like to have more information please contact elison.matioli@epfl.ch